### CHIP COIL (CHIP INDUCTOR) for Automotive infotainment/comfort equipment LQW18AS -----0Z Murata Standard Reference Specification [AEC-Q200]

#### 1. Scope

This reference specification applies to chip coil (chip inductor) LQW18AS\_0Z series based on AEC-Q200.

#### 1.1 Specific applications:

- Automotive infotainment/comfort equipment: Products that can be used for automotive equipment such as car navigation systems and car audio systems that do not directly relate to human life and whose structure, equipment, and performance are not specifically required by law to meet technical standards for safety assurance or environmental protection.
- Industrial equipment: Products that can be used in industrial equipment such as base stations, manufacturing equipment, industrial robotics equipment, and measurement equipment, and whose functions do not directly relate to the protection of human life and property.
- Medical equipment (GHTF Class C) \*Except for implant/surgery/auto injector: Products that can be used for medical
  equipment of Class C of the international classification class GHTF and whose malfunction is considered to pose a
  relatively high risk to the human body.
- Medical equipment (GHTF Class A and B): Products that can be used for medical equipment regulated by Class A and Class B of the international classification class GHTF and whose functions do not directly relate to the protection of human life and property.
- Consumer equipment: Products that can be used in consumer equipment such as home appliances, audio/visual equipment, communication equipment, information equipment, office equipment, and household robotics, and whose functions are not directly related to the protection of human life and property.

This series is designed for use in Car Multimedia, Car Interior, Car Comfort application and General Electronic equipment. It is not appropriate for use in applications critical to passenger safety and car driving function (e.g. ABS, AIRBAG, etc.).

#### 1.2 Unsuitable application:

Applications critical to passenger safety and car driving function (e.g. ABS, AIRBAG, etc.) and applications listed in "Limitation of applications" in this reference specification.

WE DISCLAIM ANY LOSS AND DAMAGES ARISING FROM OR IN CONNECTION WITH THE PRODUCTS INCLUDING BUT NOT LIMITED TO THE CASE SUCH LOSS AND DAMAGES CAUSED BY THE UNEXPECTED ACCIDENT, IN EVENT THAT THE PRODUCT IS APPLIED FOR THE PURPOSE WHICH IS SPECIFIED ABOVE AS THE UNSUITABLE APPLICATION FOR THE PRODUCT.

#### 2. Part Numbering

	W	18	A	S	1N6	J	0	Z	D
Product ID	Structure	Dimension (L × W)	Application and characteristic	Category	Inductance	Tolerance	Performance	Category Z: Automotive	Packaging D: taping *B: bulk

\*B: Bulk packing is also available (taping condition: however, products without reels are put in plastic bags).

#### 3. Part Number and Rating

Operating temperature range	-40°C to +125°C
Storage temperature range	-40°C to +125°C

		Inductance			DC	Self-resonant	Rated	ESD
Customer Part number	Murata Part number	Nominal value (nH)	Tolerance	Q (Min.)	resistance (Ω max.)	frequency (MHz min.)	current (mA)	Rank 6: 25 kV
	LQW18AS1N6J0ZD	1.6	J: ±5%	24	0.030	12500	700	6
	LQW18AS1N8J0ZD	1.8	J: ±5%	16	0.045	12500	700	6
	LQW18AS3N3G0ZD	3.3	G: ±2%	35	0.045	5900	700	6
	LQW18AS3N3J0ZD	3.3	J: ±5%	35	0.045	5900	700	6
	LQW18AS3N6G0ZD	3.6	G: ±2%	22	0.063	5900	700	6
	LQW18AS3N6J0ZD	3.6	J: ±5%	22	0.063	5900	700	6
	LQW18AS3N9G0ZD	3.9	G: ±2%	22	0.080	6900	700	6
	LQW18AS3N9J0ZD	3.9	J: ±5%	22	0.080	6900	700	6
	LQW18AS4N3G0ZD	4.3	G: ±2%	22	0.063	5900	700	6

P2/15

		Inductance			DC	Colf reconant	Deted	ESD
Customer Part number	Murata Part number	Nominal value (nH)	Tolerance	Q (Min.)	resistance (Ω max.)	Self-resonant frequency (MHz min.)	Rated current (mA)	E3D Rank 6: 25 kV
	LQW18AS4N3J0ZD	4.3	J: ±5%	22	0.063	5900	700	6
	LQW18AS4N7G0ZD	4.7	G: ±2%	20	0.116	5800	700	6
	LQW18AS4N7J0ZD	4.7	J: ±5%	20	0.116	5800	700	6
	LQW18AS5N1G0ZD	5.1	G: ±2%	20	0.140	5700	700	6
	LQW18AS5N1J0ZD	5.1	J: ±5%	20	0.140	5700	700	6
	LQW18AS5N6G0ZD	5.6	G: ±2%	26	0.075	4760	700	6
	LQW18AS5N6J0ZD	5.6	J: ±5%	26	0.075	4760	700	6
	LQW18AS6N8G0ZD	6.8	G: ±2%	27	0.110	5800	700	6
	LQW18AS6N8J0ZD	6.8	J: ±5%	27	0.110	5800	700	6
	LQW18AS7N5G0ZD	7.5	G: ±2%	28	0.106	4800	700	6
	LQW18AS7N5J0ZD	7.5	J: ±5%	28	0.106	4800	700	6
	LQW18AS8N2G0ZD	8.2	G: ±2%	30	0.115	4200	700	6
	LQW18AS8N2J0ZD	8.2	J: ±5%	30	0.115	4200	700	6
	LQW18AS8N7G0ZD	8.7	G: ±2%	28	0.109	4600	700	6
	LQW18AS8N7J0ZD	8.7	J: ±5%	28	0.109	4600	700	6
	LQW18AS9N5G0ZD	9.5	G: ±2%	28	0.135	5400	700	6
	LQW18AS9N5J0ZD	9.5	J: ±5%	28	0.135	5400	700	6
	LQW18AS10NG0ZD	10	G: ±2%	31	0.130	4800	700	6
	LQW18AS10NJ0ZD	10	J: ±5%	31	0.130	4800	700	6
	LQW18AS11NG0ZD	11	G: ±2%	30	0.086	4000	700	6
	LQW18AS11NJ0ZD	11	J: ±5%	30	0.086	4000	700	6
	LQW18AS12NG0ZD	12	G: ±2%	35	0.130	4000	700	6
	LQW18AS12NJ0ZD	12	J: ±5%	35	0.130	4000	700	6
	LQW18AS15NG0ZD	15	G: ±2%	35	0.170	4000	700	6
	LQW18AS15NJ0ZD	15	J: ±5%	35	0.170	4000	700	6
	LQW18AS16NG0ZD	16	G: ±2%	34	0.104	3300	700	6
	LQW18AS16NJ0ZD	16	J: ±5%	34	0.104	3300	700	6
	LQW18AS18NG0ZD	18	G: ±2%	35	0.170	3100	700	6
	LQW18AS18NJ0ZD	18	J: ±5%	35	0.170	3100	700	6
	LQW18AS22NG0ZD	22	G: ±2%	38	0.190	3000	700	6
	LQW18AS22NJ0ZD	22	J: ±5%	38	0.190	3000	700	6
	LQW18AS23NG0ZD	23	G: ±2%	38	0.190	2850	700	6
	LQW18AS23NJ0ZD	23	J: ±5%	38	0.190	2850	700	6
	LQW18AS24NG0ZD	24	G: ±2%	36	0.135	2650	700	6
	LQW18AS24NJ0ZD	24	J: ±5%	36	0.135	2650	700	6
	LQW18AS27NG0ZD	27	G: ±2%	40	0.220	2800	600	6
	LQW18AS27NJ0ZD	27	J: ±5%	40	0.220	2800	600	6
	LQW18AS30NG0ZD	30	G: ±2%	37	0.144	2250	600	6
	LQW18AS30NJ0ZD	30	J: ±5%	37	0.144	2250	600	6
	LQW18AS33NG0ZD	33	G: ±2%	40	0.220	2300	600	6
	LQW18AS33NJ0ZD	33	J: ±5%	40	0.220	2300	600	6
	LQW18AS36NG0ZD	36	G: ±2%	37	0.250	2080	600	6
	LQW18AS36NJ0ZD	36	J: ±5%	37	0.250	2080	600	6
	LQW18AS39NG0ZD	39	G: ±2%	40	0.250	2200	600	6
	LQW18AS39NJ0ZD	39	J: ±5%	40	0.250	2200	600	6
	LQW18AS43NG0ZD	43	G: ±2%	38	0.280	2000	600	6

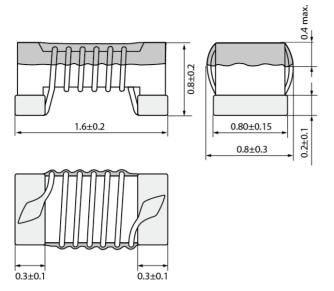
P3/15

		Inductance			50	0.14		505
Customer Part number	Murata Part number	Nominal value (nH)	Tolerance	Q (Min.)	DC resistance (Ω max.)	Self-resonant frequency (MHz min.)	Rated current (mA)	ESD Rank 6: 25 kV
	LQW18AS43NJ0ZD	43	J: ±5%	38	0.280	2000	600	6
	LQW18AS47NG0ZD	47	G: ±2%	38	0.280	2000	600	6
	LQW18AS47NJ0ZD	47	J: ±5%	38	0.280	2000	600	6
	LQW18AS51NG0ZD	51	G: ±2%	35	0.270	1900	600	6
	LQW18AS51NJ0ZD	51	J: ±5%	35	0.270	1900	600	6
	LQW18AS56NG0ZD	56	G: ±2%	38	0.310	1900	600	6
	LQW18AS56NJ0ZD	56	J: ±5%	38	0.310	1900	600	6
	LQW18AS68NG0ZD	68	G: ±2%	37	0.340	1700	600	6
	LQW18AS68NJ0ZD	68	J: ±5%	37	0.340	1700	600	6
	LQW18AS72NG0ZD	72	G: ±2%	34	0.490	1700	400	6
	LQW18AS72NJ0ZD	72	J: ±5%	34	0.490	1700	400	6
	LQW18AS82NG0ZD	82	G: ±2%	34	0.540	1700	400	6
	LQW18AS82NJ0ZD	82	J: ±5%	34	0.540	1700	400	6
	LQW18ASR10G0ZD	100	G: ±2%	34	0.580	1400	400	6
	LQW18ASR10J0ZD	100	J: ±5%	34	0.580	1400	400	6
	LQW18ASR11G0ZD	110	G: ±2%	32	0.610	1350	300	6
	LQW18ASR11J0ZD	110	J: ±5%	32	0.610	1350	300	6
	LQW18ASR12G0ZD	120	G: ±2%	32	0.650	1300	300	6
	LQW18ASR12J0ZD	120	J: ±5%	32	0.650	1300	300	6
	LQW18ASR15G0ZD	150	G: ±2%	28	0.920	990	280	6
	LQW18ASR15J0ZD	150	J: ±5%	28	0.920	990	280	6
	LQW18ASR18G0ZD	180	G: ±2%	25	1.250	990	240	6
	LQW18ASR18J0ZD	180	J: ±5%	25	1.250	990	240	6
	LQW18ASR20G0ZD	200	G: ±2%	25	1.980	900	200	6
	LQW18ASR20J0ZD	200	J: ±5%	25	1.980	900	200	6
	LQW18ASR21G0ZD	210	G: ±2%	27	2.060	895	200	6
	LQW18ASR21J0ZD	210	J: ±5%	27	2.060	895	200	6
	LQW18ASR22G0ZD	220	G: ±2%	25	2.100	900	200	6
	LQW18ASR22J0ZD	220	J: ±5%	25	2.100	900	200	6
	LQW18ASR25G0ZD	250	G: ±2%	25	3.550	822	120	6
	LQW18ASR25J0ZD	250	J: ±5%	25	3.550	822	120	6
	LQW18ASR27G0ZD	270	G: ±2%	24	2.300	900	170	6
	LQW18ASR27J0ZD	270	J: ±5%	24	2.300	900	170	6
	LQW18ASR33G0ZD	330	G: ±2%	25	3.890	900	100	6
	LQW18ASR33J0ZD	330	J: ±5%	25	3.890	900	100	6
	LQW18ASR39G0ZD	390	G: ±2%	25	4.350	900	100	6
	LQW18ASR39J0ZD	390	J: ±5%	25	4.350	900	100	6

## 4. Testing Conditions

Unless otherwise specified	Temperature: ordinary temperature (15°C to 35°C) Humidity: ordinary humidity [25% to 85% (RH)]
In case of doubt	Temperature: 20°C±2°C Humidity: 60% to 70% (RH) Atmospheric pressure: 86 kPa to 106 kPa

### 5. Appearance and Dimensions



(in mm)

Unit mass (typical value): 0.003 g

6. Marking

No marking.

#### 7. Electrical Performance

No.	Item	Specification	Test method
	Item Inductance		Test methodMeasuring equipment: Keysight E4991A or the equivalentMeasuring frequency:Inductance250 MHz1.6 nH to 43 nH200 MHz47 nH to 68 nH150 MHz72 nH to 150 nH100 MHz180 nH to 390 nHQ250 MHz1.6 nH to 43 nH200 MHz1.6 nH to 43 nH100 MHz180 nH to 390 nHQ250 MHz1.50 MHz72 nH to 150 nH100 MHz180 nH to 390 nHMeasuring conditions:
7.2	Q	Meet chapter 3 ratings.	Measurement signal level: Approx. 0 dBm Measurement terminal distance: 1.0 mm Electrical length: 10.0 mm Measuring fixture: Keysight 16197A Position the chip coil under test as shown in the measuring example below and connect it to the electrode by applying weight. Measurement example:
			Product Guide
			Measuring method: see "Electrical performance: Measuring method for inductance/Q" in the chapter "13. Appendix".
7.3	DC resistance	Meet chapter 3 ratings.	Measuring equipment: digital multimeter
7.4	Self-resonant frequency	Meet chapter 3 ratings.	Measuring equipment: Keysight N5230A or the equivalent

### 8. AEC-Q200 Requirement

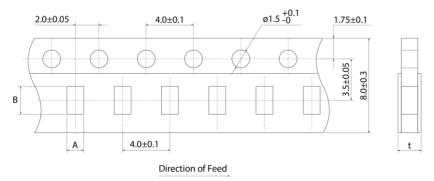
## 8.1 Performance [based on table 5 for magnetics (inductors/transformer) AEC-Q200 Rev. D issued June 1, 2010]

		AEC-Q200	Murata specification/deviation		
No.	Stress	Test method	Murata specification/deviation		
3	High temperature	1000 h at 125°C Set for 24 h at room condition, then	Meet table A after testing. Table A		
	exposure	measured.	Appearance No damage		
			Inductance change rate       Within ±5%         1.6 nH to 43 nH (at 250 MHz)       47 nH to 68 nH (at 200 MHz)         47 nH to 68 nH (at 200 MHz)       47 nH to 150 nH (at 150 MHz)         72 nH to 150 nH (at 150 MHz)       48 nH to 390 nH (at 100 MHz)		
4	Temperature cycling	1000 cycles -40°C to +125°C Set for 24 h at room condition, then measured.	Meet table A after testing.		

		AEC-Q200	Murata apositisation/doviation		
No.	Stress	Test method	Murata specification/deviation		
7	Biased humidity	1000 h at 85°C, 85% (RH). Unpowered. Set for 24 h at room condition, then measured.	Meet table A after testing.		
8	Operational life	Apply rated current 125°C 1000 h Set for 24 h at room condition, then measured.	Meet table A after testing.		
9	External visual	Visual inspection	No abnormalities		
10	Physical dimension	Meet chapter 5, "Appearance and Dimensions".	No defects		
12	Resistance to solvents	Per MIL-STD-202 Method 215	Not applicable		
13	Mechanical shock	Per MIL-STD-202 Method 213 Condition C: 100 g's (0.98 N), 6 ms, half sine, 12.3 ft/s	Meet table A after testing.		
14	Vibration	5 g's (0.049 N) for 20 min, 12 cycles each of 3 orientations Test from 10 Hz to 2000 Hz	Meet table A after testing.		
15	Resistance to soldering heat	No-heating Solder temperature 260°C±5°C Immersion time 10 s	Pre-heating: 150°C±10°C, 60 s to 90 s Meet table A after testing.		
17	ESD	Per AEC-Q200-002	ESD rank: Refer to chapter 3 ratings. Meet table A after testing.		
18	Solderbility	Per J-STD-002	Method b: not applicable 95% of the terminations is to be soldered (except exposed wire).		
19	Electrical characterization	Measured: inductance	No defects		
20	Flammability	Per UL-94	Not applicable		
21	Board flex	Epoxy-PCB (1.6 mm) Deflection 2 mm (min.) Holding time 60 s	Meet table B after testing. Table B Appearance No damage		
			DC resistance change rate Within ±10%		
22	Terminal strength	Per AEC-Q200-006 A force of 17.7 N for 60 s	Murata deviation request: 10 N for 5 s No defect		

## 9. Specification of Packaging

### 9.1 Appearance and dimensions of tape (8 mm width/paper tape)



А	(1.06)	
В	(1.86)	
t	1.1 max.	
		(in mm)

#### 9.2 Taping specifications

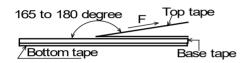
Packing quantity (Standard quantity)	4000 pcs/reel
Packing method	The products are placed in embossed cavities of a base tape and sealed by a top tape and a bottom tape.
Feed hole position	The feed holes on the base tape are on the right side when the top tape is pulled toward the user.
Joint	The base tape and the top tape are seamless.
Number of missing products	Number of missing products within 0.025% of the number per reel or 1 pc., whichever is greater, and are not continuous. The specified quantity per reel is kept.

#### 9.3 Break down force of tape

Break down force of top tape	5 N min.
Break down force of bottom tape	5 N min.

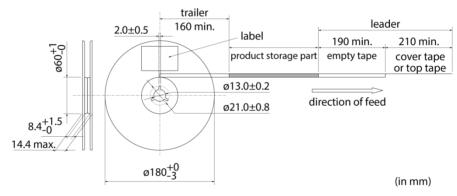
#### 9.4 Peeling off force of top tape

Speed of peeling off	300 mm/min
Peeling off force	0.1 N to 0.6 N (The lower limit is for typical value.)



#### 9.5 Dimensions of leader section, trailer section and reel

A vacant section is provided in the leader (start) section and trailer (end) section of the tape for the product. The leader section is further provided with an area consisting only of the cover tape (or top tape). (See the diagram below.)



#### 9.6 Marking for reel

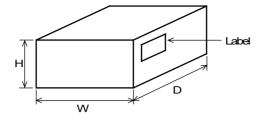
Customer part number, Murata part number, inspection number (\*1), RoHS marking (\*2), quantity, etc.

*1 Expression of inspection No.: $ \begin{array}{c c}                                    $	<ul> <li>(1) Factory code</li> <li>(2) Date</li> <li>First digit: year/last digit of year</li> <li>Second digit: month/Jan. to Sep.→1 to 9, Oct. to Dec.→O, N, D</li> <li>Third, Fourth digit: day</li> <li>(3) Serial No.</li> </ul>
	<ul><li>(1) RoHS regulation conformity</li><li>(2) Murata classification number</li></ul>

#### 9.7 Marking on outer box (corrugated box)

Customer name, purchasing order number, customer part number, Murata part number, RoHS marking (\*2), quantity, etc.

#### 9.8 Specification of outer box



Dimensions of outer box (mm)		Standard reel quantity	
W	D	Н	in outer box (reel)
186 186 93		5	
* Above outer box size is typical. It depends on a quantity of an order.			

### 10. **A**Caution

#### **10.1 Limitation of applications**

The products listed in the reference specification (hereinafter the product(s) is called as the "Product(s)") are designed and manufactured for applications specified in the reference specification (hereinafter called as the "Specific Application"). We shall not warrant anything in connection with the Products including fitness, performance, adequateness, safety, or quality, in the case of applications listed in from (1) to (11) written at the end of this precautions, which may generally require high performance, function, quality, management of production or safety. Therefore, the Product shall be applied in compliance with the specific application.

WE DISCLAIM ANY LOSS AND DAMAGES ARISING FROM OR IN CONNECTION WITH THE PRODUCTS INCLUDING BUT NOT LIMITED TO THE CASE SUCH LOSS AND DAMAGES CAUSED BY THE UNEXPECTED ACCIDENT, IN EVENT THAT (i) THE PRODUCT IS APPLIED FOR THE PURPOSE WHICH IS NOT SPECIFIED AS THE SPECIFIC APPLICATION FOR THE PRODUCT, AND/OR (ii) THE PRODUCT IS APPLIED FOR ANY FOLLOWING APPLICATION PURPOSES FROM (1) TO (11) (EXCEPT THAT SUCH APPLICATION PURPOSE IS UNAMBIGUOUSLY SPECIFIED AS SPECIFIC APPLICATION FOR THE PRODUCT IN OUR CATALOG SPECIFICATION FORMS, DATASHEETS, OR OTHER DOCUMENTS OFFICIALLY ISSUED BY US\*).

- (1) Aircraft equipment
- (2) Aerospace equipment
- (3) Undersea equipment
- (4) Power plant control equipment
- (5) Medical equipment
- (6) Transportation equipment
- (7) Traffic control equipment
- (8) Disaster prevention/security equipment
- (9) Industrial data-processing equipment
- (10) Combustion/explosion control equipment
- (11) Equipment with complexity and/or required reliability equivalent to the applications listed in the above.

For exploring information of the Products which will be compatible with the particular purpose other than those specified in the reference specification, please contact our sales offices, distribution agents, or trading companies with which you make a deal, or via our web contact form.

Contact form: https://www.murata.com/contactform

\* We may design and manufacture particular Products for applications listed in (1) to (11). Provided that, in such case we shall unambiguously specify such Specific Application in the reference specification without any exception. Therefore, any other documents and/or performances, whether exist or non-exist, shall not be deemed as the evidence to imply that we accept the applications listed in (1) to (11).

#### **10.2 Precautions on rating**

Avoid using in exceeded the rated temperature range, rated voltage, or rated current.

Usage when the ratings are exceeded could lead to wire breakage, burning, or other serious fault.

#### 10.3 Inrush current

If an inrush current (or pulse current or rush current) that significantly exceeds the rated current is applied to the product, overheating could occur, resulting in wire breakage, burning, or other serious fault.

#### 10.4 Fail-safe

Be sure to provide an appropriate fail-safe function on your product to prevent a second damage that may be caused by the abnormal function or the failure of our product.

#### 10.5 Corrosive gas

Please refrain from use since contact with environments with corrosive gases (sulfur gas [hydrogen sulfide, sulfur dioxide, etc.], chlorine, ammonia, etc.) or oils (cutting oil, silicone oil, etc.) that have come into contact with the previously stated corrosive gas environment will result in deterioration of product quality or an open from deterioration due to corrosion of product electrode, etc. We will not bear any responsibility for use under these environments.

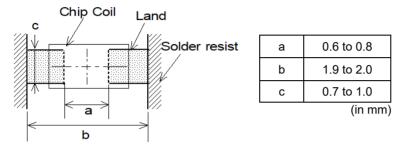
#### 11. Precautions for Use

This product is for use only with reflow soldering. It is designed to be mounted by soldering. If you want to use other mounting method, for example, using a conductive adhesive, please consult us beforehand. Also, if repeatedly subjected to temperature cycles or other thermal stress, due to the difference in the coefficient of thermal expansion with the mounting substrate, the solder (solder fillet part) in the mounting part may crack. The occurrence of cracks due to thermal stress is affected by the size of the land where mounted, the solder volume, and the heat dissipation of the mounting substrate. Carefully design it when a large change in ambient temperature is assumed.

#### 11.1 Land dimensions

The following diagram shows the recommended land dimensions for reflow soldering.

The land dimensions are designed in consideration of electrical characteristics and mountability. Use of other land dimensions may preclude achievement of performance. In some cases, it may result in poor solderability, including positional shift. If you use other land pattern, consider it adequately.



#### 11.2 Flux and solder used

<ul> <li>Use a rosin-based flux that includes an activator with a chlorine conversion value of 0.06 mass% to 0.1 mass%.</li> <li>Do not use a highly acidic flux with a halide content exceeding 0.2 mass% (chlorine conversion value).</li> <li>Do not use a water-soluble flux.</li> </ul>
<ul> <li>Use Sn-3.0Ag-0.5Cu solder.</li> <li>Standard thickness of solder paste: 100 μm to 150 μm</li> </ul>

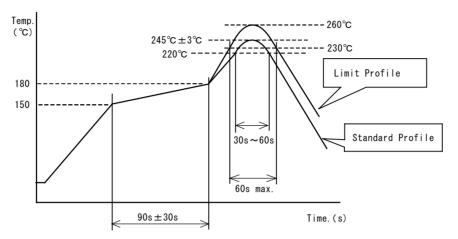
If you want to use a flux other than the above, please consult our technical department.

#### 11.3 Soldering conditions (reflow)

• Pre-heating should be in such a way that the temperature difference between solder and product surface is limited to 150°C max.

Cooling into solvent after soldering also should be in such a way that the temperature difference is limited to 100°C max. Insufficient pre-heating may cause cracks on the product, resulting in the deterioration of product guality.

• Standard soldering profile and the limit soldering profile is as follows. The excessive limit soldering conditions may cause leaching of the electrode and/or resulting in the deterioration of product quality.



	Standard profile	Limit profile
Pre-heating	150°C to 180°C/90 s±30 s	150°C to 180°C/90 s±30 s
Heating	Above 220°C/30 s to 60 s	Above 230°C/60 s max.
Peak temperature	245°C±3°C	260°C/10 s
Number of reflow cycles	2 times	2 times

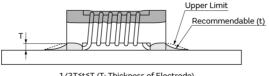
#### 11.4 Reworking with soldering iron

The following requirements must be met to rework a soldered product using a soldering iron.

Item	Requirement	
Pre-heating	150°C/approx. 1 min	
Tip temperature of soldering iron	350°C max.	
Power consumption of soldering iron	80 W max.	
Tip diameter of soldering iron	ø3 mm max.	
Soldering time	3 s (+1 s, -0 s)	
Number of reworking operations	2 times max.	
* Avoid a direct contact of the tip of the soldering iron with the product. Such a direction contact may cause cracks in the ceramic body due to thermal shock.		

#### 11.5 Solder volume

Solder shall be used not to increase the volume too much.



1/3T≦t≦T (T: Thickness of Electrode)

An increased solder volume increases mechanical stress on the product. Exceeding solder volume may cause the failure of mechanical or electrical performance.

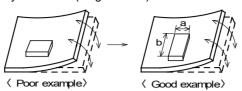
Spec No.: JELF243A 9139E-01

## Reference Only

#### 11.6 Product's location

- The following shall be considered when designing and laying out PCBs.
- (1) PCB shall be designed so that products are not subject to mechanical stress due to warping the board. [Products direction]

Products shall be located in the sideways direction (length: a < b) to the mechanical stress.

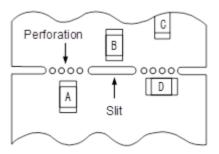


#### (2) Components location on PCB separation

It is effective to implement the following measures, to reduce stress in separating the board.

It is best to implement all of the following three measures; however, implement as many measures as possible to reduce stress.

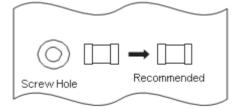
Contents of measures	Stress level
(1) Turn the mounting direction of the component parallel to the board separation surface.	A > D <sup>*1</sup>
(2) Add slits in the board separation part.	A > B
(3) Keep the mounting position of the component away from the board separation surface.	A > C
*1 A > D is valid when stress is added vertically to the perforation as with hand separation. If a cutting disc is used, stress will be diagonal to the PCB, therefore A > D is invalid.	



(3) Mounting components near screw holes

When a component is mounted near a screw hole, it may be affected by the board deflection that occurs during the tightening of the screw.

Mount the component in a position as far away from the screw holes as possible.

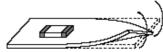


#### 11.7 Handling of substrate

After mounting products on a substrate, do not apply any stress to the product caused by bending or twisting to the substrate when cropping the substrate, inserting and removing a connector from the substrate or tightening screw to the substrate. Excessive mechanical stress may cause cracking in the product.



Bending



Twisting

#### 11.8 Cleaning

The product shall be cleaned under the following conditions.

- (1) The cleaning temperature shall be 60°C max. If isopropyl alcohol (IPA) is used, the cleaning temperature shall be 40°C max.
- (2) Perform ultrasonic cleaning under the following conditions. Exercise caution to prevent resonance phenomenon in mounted products and the PCB.

Item	Requirement	
Power	20 W/L max.	
Time	5 min max.	
Frequency	28 kHz to 40 kHz	

(3) Cleaner

Alcohol-based cleaner: IPA

Aqueous agent: PINE ALPHA ST-100S

- (4) There shall be no residual flux or residual cleaner. When using aqueous agent, rinse the product with deionized water adequately and completely dry it so that no cleaner is left.
- \* For other cleaning, consult our technical department.

#### 11.9 Storage and transportation

Storage period	Use the product within 12 months after delivery. If you do not use the product for more than 12 months, check solderability before using it.
Storage conditions	<ul> <li>The products shall be stored in a room not subject to rapid changes in temperature and humidity. The recommended temperature range is -10°C to +40°C. The recommended relative humidity range is 15% to 85%.</li> <li>Keeping the product in corrosive gases, such as sulfur, chlorine gas or acid may cause the poor solderability.</li> <li>Do not place the products directly on the floor; they should be placed on a palette so that they are not affected by humidity or dust.</li> <li>Avoid keeping the products in a place exposed to direct sunlight, heat or vibration.</li> <li>Do not keep products in bulk packaging. Bulk storage could result in collisions between the products or between the products and other parts, resulting in chipping or wire breakage.</li> <li>Avoid storing the product by itself bare (i.e. exposed directly to air).</li> </ul>
Transportation	Excessive vibration and impact reduces the reliability of the products. Exercise caution when handling the products.

#### 11.10 Resin coating (including moisture-proof coating)

When the product is coated/molded with resin, its electrical characteristics may change.

A wire breakage issue may occur by mechanical stress caused by the resin, amount/cured shape of resin, or operating condition etc.

Some resins contain impurities or hydrolyzable chlorine, which could result in corrosion of the conducting materials, leading to wire breakage.

So, please pay your careful attention when you select resin in case of coating/molding the products with the resin. Prior to use the coating resin, please make sure no reliability issue is observed by evaluating products mounted on your board.

#### **11.11 Mounting conditions**

Check the mounting condition before using.

Using mounting conditions (nozzles, equipment conditions, etc.) that are not suitable for products may lead to pick up errors, misalignment, or damage to the product.

With some types of mounting equipment, a support pin pushes up the product from the bottom of the base (paper) tape when the product is sucked with the pick-up nozzle. When using this type of equipment, detach the support pin to prevent the breaking of wire on the product.

In some cases, the laser recognition function of the mounting equipment may not recognize this product correctly. Please contact us when using laser recognition. (There is no problem with the permeation and reflection type.)

#### 11.12 Operating environment

Do not use this product under the following environmental conditions as it may cause deterioration of product quality.

- (1) In the corrodible atmosphere such as acidic gases, alkaline gases, chlorine, sulfur gases, organic gases and etc. (the sea breeze, Cl2, H2S, NH3, SO2, NO2, etc)
- (2) In the atmosphere where liquid such as organic solvent, may splash on the products.
- (3) In the atmosphere where the temperature/humidity changes rapidly and it is easy to dew.



#### 11.13 Mounting density

If this product is placed near heat-generating products, be sure to implement sufficient heat-dissipating measures. If this product is subjected to a significant amount of heat from other products, this could adversely affect product quality, resulting in a circuit malfunction or failure of the mounted section. Also, be sure that the product is used in a manner so that the heat that the product is subjected to from other products does not exceed the upper limit of the rated operating temperature for the product.

#### 11.14 Handling of product

- To prevent wire breakage, sharp objects such as tweezers, bristles of cleaning brushes, and other objects must not contact the winding section or the electrode section.
- Mechanical shock should not be applied to the products mounted on the board to prevent the breaking of the core.

### 12. 🗥 Note

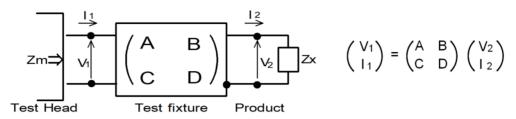
- (1) Please make sure that your product has been evaluated in view of your specifications with our product being mounted to your product.
- (2) You are requested not to use our product deviating from the reference specifications.
- (3) The contents of this reference specification are subject to change without advance notice. Please approve our product specifications or transact the approval sheet for product specifications before ordering.

#### 13. Appendix

Electrical performance: Measuring method for inductance/Q (Q measurement is applicable only when the Q value is included in the rating table.)

Perform measurement using the method described below. (Perform correction to ensure that the inductance value is compatible with inductors of other manufacturers.)

(1) Residual elements and stray elements of the measuring terminal can be expressed by the F parameter for the 2-pole terminal as shown in the figure below.



(2) The product's impedance value (Zx) and measured impedance value (Zm) can be expressed as shown below, by using the respective current and voltage for input/output.

$$Zm = \frac{V_1}{I_1} \qquad Zx = \frac{V_2}{I_2}$$

(3) Thus, the relationship between the product's impedance value (Zx) and measured impedance value (Zm) is as follows.

	Here, $\alpha = D/A = 1$ $\beta = B/D = Zsm - (1 - Yom Zsm) Zss$
$Zx=\alpha \frac{Zm-\beta}{1-Zm\Gamma}$	$\Gamma = C/A = Yom$
	Zsm: measured impedance when measuring terminal is shorted
	Zss: residual impedance of short chip (= Equivalent series inductance X <sup>*1</sup> )
	Yom: measured admittance when measuring terminal is open

\*1 Important

X: In consideration of compatibility with other venders' products, Zss is defined as the correction value to fit nominal inductance of other venders' products.

When calibrating the measurement, please input X value instead of the equivalent series inductance (ShortL) for each L value.

Perform measurement of Q using the residual impedance 0.771 nH obtained through our conventional standard measurement method.

#### (4) Calculate inductance Lx and Qx using the equations shown below.

$Lx = \frac{Im (Zx)}{2\pi f}$	Lx: inductance of chip coil	
$Qx = \frac{Im (Zx)}{Re (Zx)}$	Qx: Q of chip coil f: measuring frequency	

Table: Equivalent series inductance to fit nominal inductance of other venders' products

	Inductance	
Part number	X (nH) Equivalent series inductance	Measuring frequency (MHz)
LQW18AS1N6_0Z	0.131	250
LQW18AS1N8_0Z	0.061	250
LQW18AS3N3_0Z	0.111	250
LQW18AS3N6_0Z	0.231	250
LQW18AS3N9_0Z	0.011	250
LQW18AS4N3_0Z	0.251	250
LQW18AS4N7_0Z	0.301	250
LQW18AS5N1_0Z	0.071	250

Part number	Inductance	
	X (nH) Equivalent series inductance	Measuring frequency (MHz)
LQW18AS5N6_0Z	-0.079	250
LQW18AS6N8_0Z	-0.019	250
LQW18AS7N5_0Z	0.201	250
LQW18AS8N2_0Z	0.281	250
LQW18AS8N7_0Z	0.221	250
LQW18AS9N5_0Z	0.021	250
LQW18AS10N_0Z	-0.089	250
LQW18AS11N_0Z	0.321	250
LQW18AS12N_0Z	-0.189	250
LQW18AS15N_0Z	-0.369	250
LQW18AS16N_0Z	0.271	250
LQW18AS18N_0Z	-0.429	250
LQW18AS22N_0Z	-0.419	250
LQW18AS23N_0Z	-0.509	250
LQW18AS24N_0Z	0.401	250
LQW18AS27N_0Z	0.171	250
LQW18AS30N_0Z	-0.219	250
LQW18AS33N_0Z	-0.589	250
LQW18AS36N_0Z	-0.299	250
LQW18AS39N_0Z	-0.859	250
LQW18AS43N_0Z	0.231	250
LQW18AS47N_0Z	-0.769	200
LQW18AS51N_0Z	-0.949	200
LQW18AS56N_0Z	-1.299	200
LQW18AS68N_0Z	-1.739	200
LQW18AS72N_0Z	-1.089	150
LQW18AS82N_0Z	-1.909	150
LQW18ASR10_0Z	-1.729	150
LQW18ASR11_0Z	-2.829	150
LQW18ASR12_0Z	-3.429	150
LQW18ASR15_0Z	-4.429	150
LQW18ASR18_0Z	-5.129	100
LQW18ASR20_0Z	-4.629	100
LQW18ASR21_0Z	-2.029	100
LQW18ASR22_0Z	-5.229	100
LQW18ASR25_0Z	-4.029	100
LQW18ASR27_0Z	-4.329	100
LQW18ASR33_0Z	-8.329	100
LQW18ASR39_0Z	-13.329	100